

21 June 2004

Updated Search

09/829,500

L Number	Hits	Search Text	DB	Time stamp
2	9395	428/141,336,432,698.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 11:19
3	69	428/141,336,432,698.ccls. and (inkjet or (ink adj ket) or printhead or (print adj head) or (orifice adj plate))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 11:26
4	4832	428/141,336,432,698.ccls. and glass	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 11:27
5	1548	428/141,336,432,698.ccls. and (glass near substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 11:27
6	264	(428/141,336,432,698.ccls. and (glass near substrate)) and (metal with dielectric)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 11:28
7	600	(428/141,336,432,698.ccls. and (glass near substrate)) and (raised or land or projection or protuberance or recess or trench or peak)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 11:28
8	200	(428/141,336,432,698.ccls. and (glass near substrate)) and ((raised or land or projection or protuberance or recess or trench or peak) with substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 11:30
9	83	((428/141,336,432,698.ccls. and (glass near substrate)) and ((raised or land or projection or protuberance or recess or trench or peak) with substrate)) and (dielectric or (silicon adj carbide) or sic)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 11:30
-	186	mandrel same (printhead or (print adj head) or inkjet or "ink-jet" or (ink adj jet))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 11:19
-	37	(mandrel same (printhead or (print adj head) or inkjet or "ink-jet" or (ink adj jet))) and mandrel.ti.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/15 10:04

-	186	(mandrel same (printhead or (print adj head) or inkjet or "ink-jet" or (ink adj jet))) and mandrel	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/15 10:45
-	191	mandrel same (printhead or (print adj head) or inkjet or "ink-jet" or (ink adj jet) or oriface)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/22 09:34
-	27	5560837.URPN.	USPAT	2003/07/15 11:18
-	1	6589112.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/15 11:34
-	1	6586112.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/15 11:35
-	1228	29/890.1.ccls. 347/20.ccls. 428/195.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/15 11:42
-	15	(29/890.1.ccls. 347/20.ccls. 428/195.ccls.) and mandrel and (inkjet or (ink adj jet) or printhead or (print adj head))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/15 11:47
-	2	((mandrel same (printhead or (print adj head) or inkjet or "ink-jet" or (ink adj jet))) and mandrel) and leader.xa.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/15 11:48
-	352	204/281.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/15 11:48
-	3	204/281.ccls. and (mandrel same (printhead or (print adj head) or inkjet or "ink-jet" or (ink adj jet)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/15 11:52
-	7	204/281.ccls. and (glass near2 substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/15 11:53

-	34	204/281.ccls. and glass	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/15 11:53
-	9	("3561964" "4142893" "4229265" "4250242" "4264714" "4288282" "4773971" "4839001" "4954225").PN.	USPAT	2003/07/15 14:16
-	1	849024.apn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/15 15:17
-	1	942477.apn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/15 15:17
-	758	electroform\$3 same (inkjet or (ink adj jet) or printhead or (print adj head) or (nozzle adj plate))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/21 08:56
-	758	electroform\$3 same (inkjet or (ink adj jet) or printhead or (print adj head) or (nozzle adj plate) or (orifice adj sheet))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/21 08:58
-	89	electroform\$3 same (inkjet or (ink adj jet) or printhead or (print adj head) or (nozzle adj plate) or (orifice adj sheet)) same (mandrel or mold)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/21 09:00
-	105	electroform\$3 same (inkjet or (ink adj jet) or printhead or (print adj head) or (nozzle adj (plate or sheet)) or (orifice adj (sheet or plate))) same (mandrel or mold)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/21 11:02
-	1	829500.apn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/21 11:02
-	6	204/281.ccls. and (inkjet or (ink adj jet) or printhead or (print adj head) or (nozzle adj (plate or sheet)) or (orifice adj (sheet or plate)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/21 11:07
-	8	204/281.ccls. and (substrate near2 glass)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/21 11:22

-	36	204/281.ccls. and glass	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/21 11:22
-	359	204/281.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/21 13:18
-	744	205/67,75,76.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/21 13:18
-	90	205/67,75,76.ccls. and screen	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/21 13:51
-	4	2702270.URPN.	USPAT	2004/04/21 13:34
-	38	205/67,75,76.ccls. and (glass near (substrate or mandrel or mold))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/21 13:51
-	3	3703450.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/22 09:32
-	0	204/281.ccls. and (((silicon adj carbide) or Sic!) with ((silicon adj nitride) or SiN!))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/22 09:33
-	116	electroform\$3 and (((silicon adj carbide) or Sic!) with ((silicon adj nitride) or SiN!))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/22 09:33
-	9	(electroform\$3 and (((silicon adj carbide) or Sic!) with ((silicon adj nitride) or SiN!))) and (mandrel same (printhead or (print adj head) or inkjet or "ink-jet" or (ink adj jet) or oriface))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/22 09:34
-	4	204/281.ccls. and (inkjet or (ink adj ket) or printhead or (print adj head) or (orifice adj plate))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/21 11:20

-	1323	347/47.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/15 15:38
-	34	347/47.ccls. and mandrel	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/15 15:39